

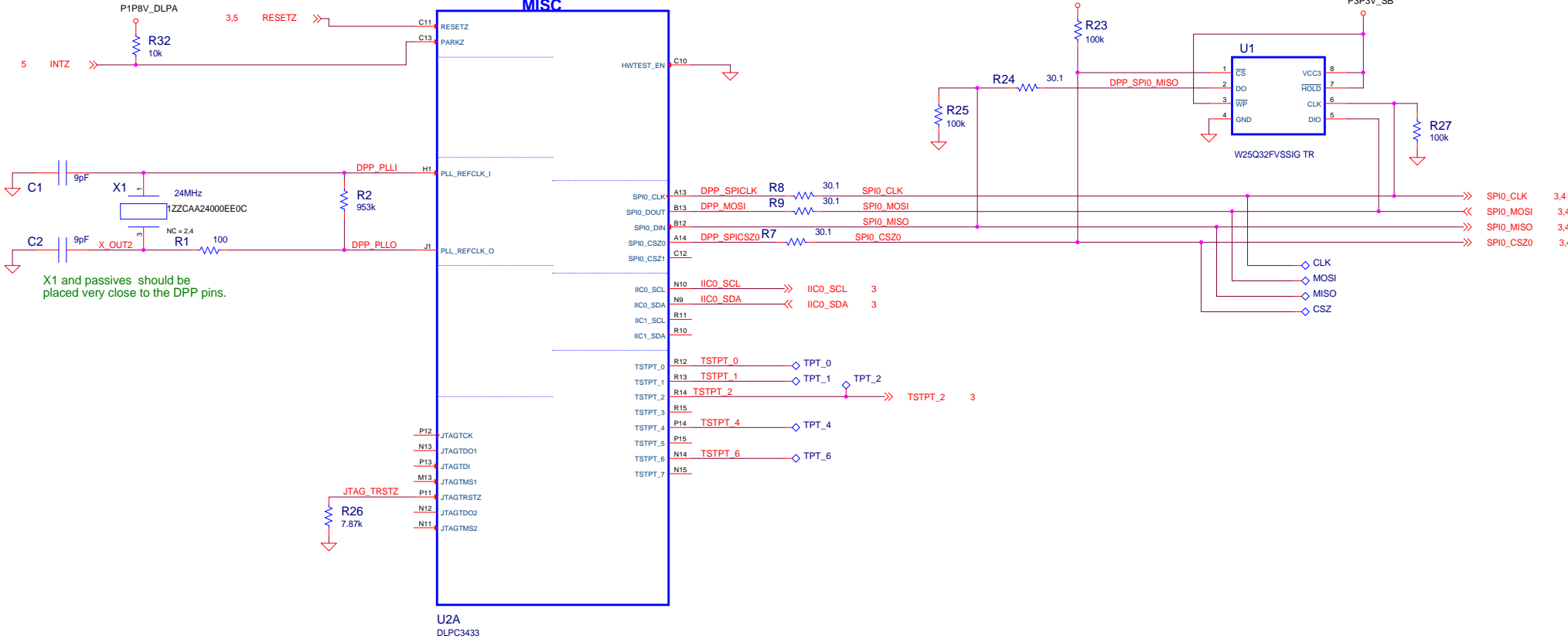
Revision History:

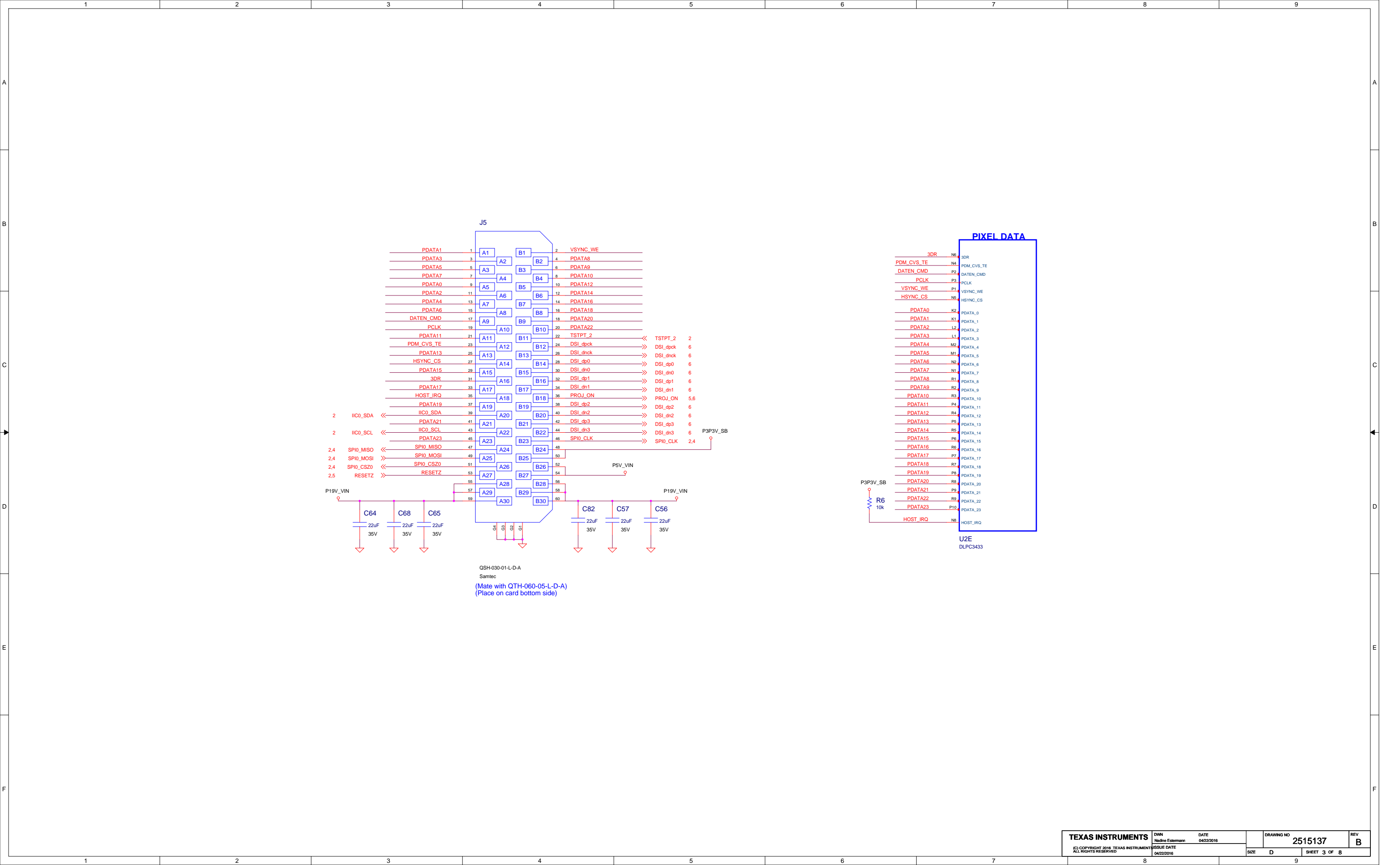
- E.0: Initial Engineering Release
- A: Added pull-up on INT2 to 1.8V; Removed testpoints on TSTPT\_3,5,7; Added testpoints on GPIO\_17,19
- B: Minor Layout updates adjusted version number of schematic to match with layout

ESD 2515137  
PCB 2515138  
CCA 2515139

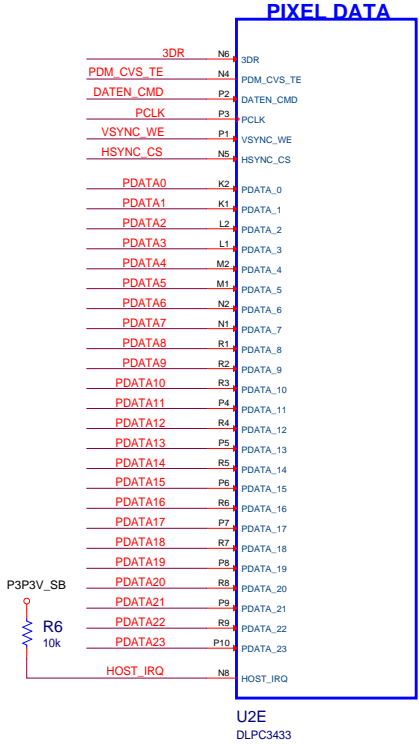
DWN	Nadine Estermann	DATE	APR-22-2016	TEXAS INSTRUMENTS - DLP® Products		
ENGR	Nadine Estermann		APR-22-2016	(C) COPYRIGHT 2016 Texas Instruments Inc. All Rights Reserved		
SYS	Dan Morgan	---		TITLETIDA-01571 DLP Display LightCrafter 3010 Gen2 Display Board		
APVD	Jeff Dennis	---		DRAWING NO	2515137	REV B
QA	---	---		11 x 17	Orcad Capture 16.6	SHEET 1 of 8

## DLPC3433 Clock, Reset, SPI and Flash Memory

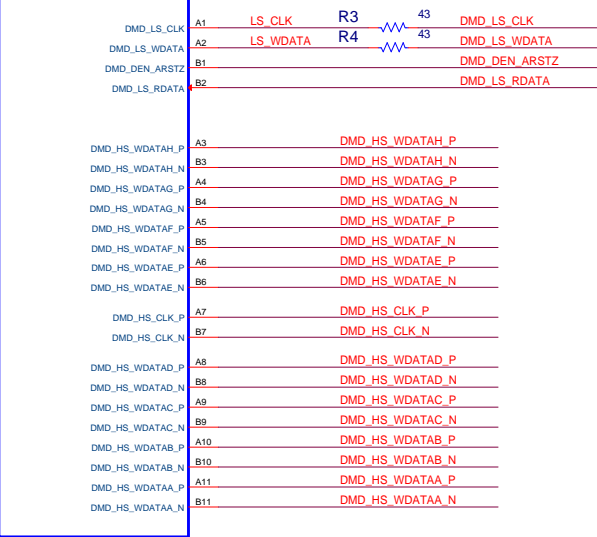




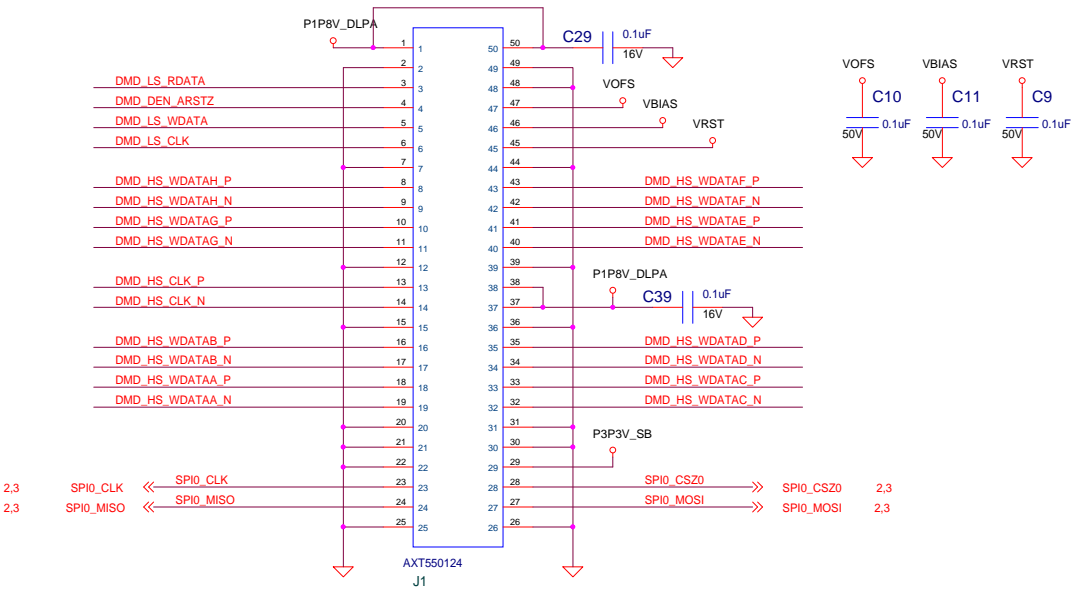
QSH-030-01-L-D-A  
Samtec  
(Mate with QTH-060-05-L-D-A)  
(Place on card bottom side)



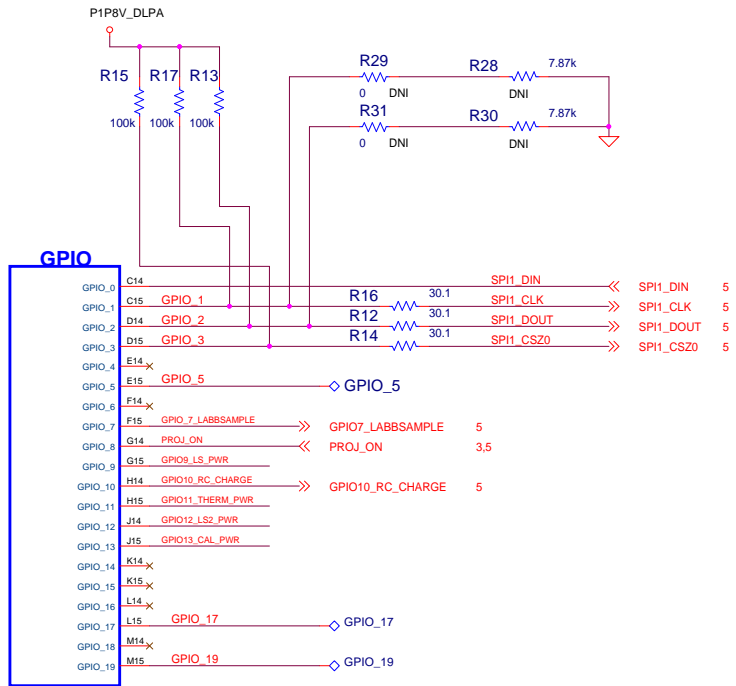
DMD INTERFACE



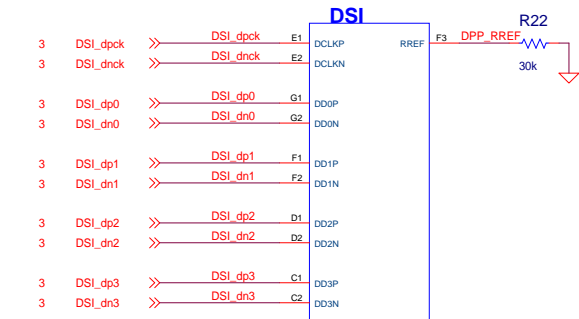
U2B  
DLPC3433



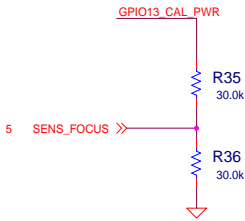




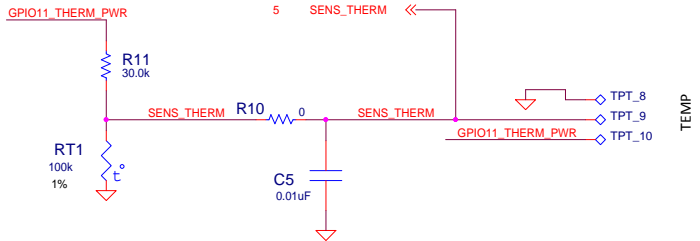
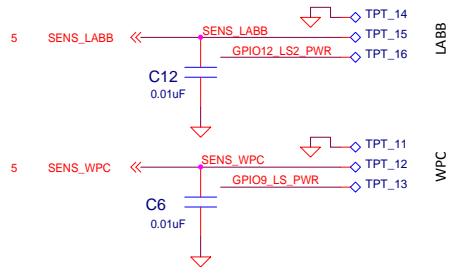
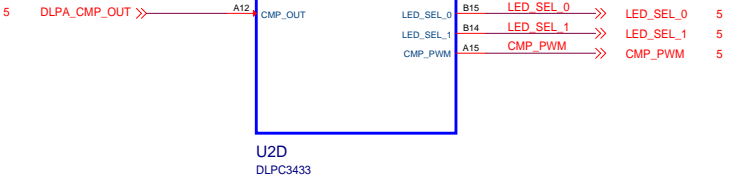
U2C  
DLPC3433



U2F  
DLPC3433



**LED CNTL**





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							<table><tr><td>TEXAS INSTRUMENTS</td><td>DWN Nedine Estermann</td><td>DATE 04/22/2016</td><td>DRAWING NO 2515137</td><td>REV B</td></tr><tr><td>(C) COPYRIGHT 2016, TEXAS INSTRUMENTS ALL RIGHTS RESERVED</td><td>ISSUE DATE 04/22/2016</td><td>SIZE D</td><td colspan="2">SHEET 8 OF 8</td></tr></table>	TEXAS INSTRUMENTS	DWN Nedine Estermann	DATE 04/22/2016	DRAWING NO 2515137	REV B	(C) COPYRIGHT 2016, TEXAS INSTRUMENTS ALL RIGHTS RESERVED	ISSUE DATE 04/22/2016	SIZE D	SHEET 8 OF 8	
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